### **General Description**

The MC4996 is an audio power amplifier primarily designed for demanding applications in mobile phones and other portable communication device applications. It is capable of delivering 1 watts of continuous average power to an  $8\Omega$  BTL load with less than 1% distortion (THD+N) from a 5V DC power supply.

The MC4996 were specifically designed to provide high quality output power with a minimal amount of external components. It requires no output coupling capacitors, for this reason, it is perfectly meet the needs of mobile phone and other low voltage applications where require the consumption of power in the smallest amount.

The MC4996 can offer a low standby current and a zero shutdown current. Furthermore, the wake up time of the amplifier is fast enough to use shutdown mode as a mute function.

The MC4996 has an advanced pop & click circuitry that eliminates the noise during turning on and turning off of the device.

#### **Features**

- Po at 1% THD+N, VDD = 5V RL = 8Ω 1.2W
- Po at 10% THD+N, VDD = 5V
   RL = 8Ω 1.50W
- Po at 1% THD+N, VDD = 3.0V  $RL = 8\Omega \ 0.36W (typ)$
- Po at 1% THD+N, VDD = 2.6V
   RL = 8Ω 0.27W (typ)
- 2.5-5.5V operation
- 0.1µA ultra low current shutdown mode
- · Less external components required
- · Thermal and over current protections
- Space saving package DFN 2X2 8L
- RoHS compliant and 100% lead(Pb)-free

### **Applications**

- Mobile Phones
- PDAs
- Portable Electronic Devices

#### **Function Block Diagram**

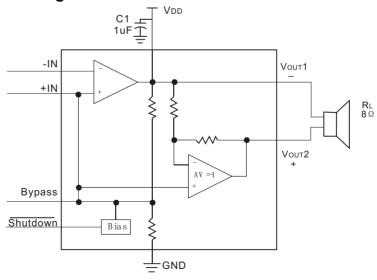


Figure1.

www.megapower.com.cn 1 Feb.2012 Rev.2.0



# **Pin Configuration**

DFN 2X2\_8L

SHUTDOWN 1 8 Vo2

BYPASS/+IN 2 7 GND

BYPASS/+IN 3 6 VDD

-IN 4 5 Vo1

## **Pin Descriptions**

Pin#	Symbol	Function
1	SHUTDOWN	Shutdown terminal active low
2,3	BYPASS/IN+	Bypass capacitor pin which provides the common mode voltage or Positive input
4	IN-	Negative input
5	Vo1	Negative output
6	Vdd	Analog power supply.
7	GND	Ground
8	Vo2	Positive output

# **Typical Application**

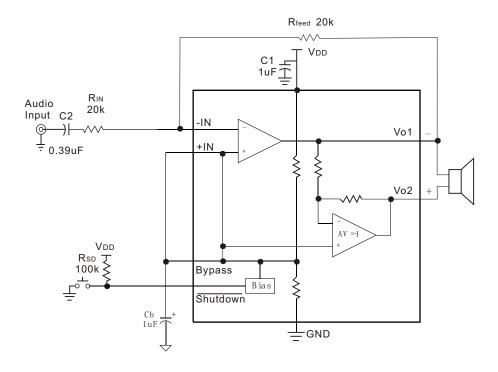


Figure 2. Typical Application



## Absolute Maximum Ratings<sup>1</sup>

Symbol	Description	Value	Unit
$V_{DD}$	Supply Voltage at no Input Signal	6	V
V <sub>I</sub>	Input Voltage	-0.3 to VDD+0.3	V
TJ	Operating Junction Temperature Range	-40 to 150	°C
T <sub>SDR</sub>	Maximum Lead Soldering Temperature , 10 Seconds	280	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to 150	°C

## **Recommended Operating Conditions**

Symbol	Description	Value	Unit
V <sub>DD</sub>	Supply Voltage	2. 4~5.5	V
TA	Ambient Temperature Range	-40~85	°C
Tu	Junction Temperature Range	-40~125	°C

#### Thermal Information<sup>2</sup>

Symbol	Description	Value	Unit
$\theta_{JA}$	Thermal Resistance-Junction to Ambient	80	°C/W
$\theta_{\sf JC}$	Thermal Resistance-Junction to Case	15	°C/W

## **Ordering and Marking Information**

Device	Package Type	Marking	Reel Size	Tape Width	Quantity
MC4996	DFN 2X2_8L	4996 xxxx	7"	8mm	3000 units

### **ESD Susceptibility**

ESD Susceptibility-HBM	 2kV
ESD Susceptibility-MM	 200V

- Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at
  conditions other than the operating conditions specified is not implied. Only one Absolute Maximum Rating should be applied at
  one time.
- 2. The ThermalPad on the bottom of the IC should soldered directly to the PCB's ThermalPad area that with several thermal vias connect to the ground plan, and the PCB is a 2-layer, 5-inch square area with 2oz copper thickness.



## **Electrical Characteristics**

( $V_{DD} = 5V$ ,  $T_A = 25$ °C unless otherwise specified)

Symbol		Parameter	Min.	Тур.	Max.	Unit
I <sub>CC</sub>	Supply current No input signal, no load			3	6	mA
I <sub>SD</sub>		Shutdown current No input signal, $Vsp = GND$ , $R_L = 8\Omega$			2	uA
V <sub>oo</sub>	Output offset volta No input signal, R	· ·		3	30	mV
P <sub>out</sub>	$\begin{array}{c} V_{\text{DD}} = 5V \\ R_{\text{L}} = 8\Omega \end{array} \qquad \begin{array}{c} THD + N = 1\% \; (\text{max}); \; f = 1 \text{kHz} \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ V_{\text{DD}} = 4. \; 2V \\ R_{\text{L}} = 8\Omega \end{array} \qquad \begin{array}{c} THD + N = 1\% \; (\text{max}); \; f = 1 \text{kHz} \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ V_{\text{DD}} = 3. \; 6V \\ THD + N = 10\% (\text{max}); \; f = 1 \text{kHz} \\ THD$		0.95	1.2 1. 5 0. 83 1. 03 0. 67 0. 84 0. 75 0. 39 0. 49		W W W W W W W
THD + N	Total harmonic distortion + noise	$V_{DD}=5V 20Hz \le F \le 20kHz$ $Pout = 0.8Wrms, Av = 2, R_L = 8\Omega$ $V_{DD}=3. 6V20Hz \le F \le 20kHz$		0.03		%
PSRR	$Pout = 0.5 Wrms, Av = 2 , R_L = 8 \Omega$ $Power supply rejection ratio (1) \\ R_L = 8 \Omega, A_V = 2, V_{ripple} = 200 mVpp, input grounded \\ f = 217 Hz \\ f = 1 kHz$			0.05 63 67		% dB
t <sub>WU</sub>	Wake-up time ( $C_b = 1\mu F$ )			100		ms
t <sub>SD</sub>	Shutdown Time(C <sub>b</sub> = 1µF)			10		μs
V <sub>SDH</sub>	Shutdown Voltage	e level high	1.3			V
V <sub>SDL</sub>	Shutdown Voltage	e level low			0.4	V

All PSRR data limits are guaranteed by production sampling tests.
 Dynamic measurements - 20\*log(rms(Vout)/rms(Vripple)). Vripple is the sinusoidal signal superimposed upon Vcc.
 The Exposed-DAP should be electrically connected to GND or an electrically isolated copper area.



### **Electrical Characteristics**

( $V_{DD} = 3.0V$ ,  $T_A = 25$ °C unless otherwise specified)

Symbol	Parameter			Тур.	Max.	Unit
I <sub>CC</sub>	Supply curren No input signa			1.15	5	mA
I <sub>SD</sub>	Shutdown cur No input signa	rent I, $V_{SD}$ = GND, $R_L$ = 8 $\Omega$		0.19	2	uA
V <sub>oo</sub>	Output offset v No input signa			3	30	mV
P <sub>out</sub>	Output power	THD+N = 1% (max); f = 1kHz (8 Ω)	0.28	0.36		mW
THD + N	Total harmonic distortion + noise $P_{out} = 0.25 Wrms, A_V = 2, 20 Hz \le F \le 20 kHz, \\ R_L = 8 \ \Omega$			0.08	0.25	%
PSRR	Power supply rejection ratio <sup>(1)</sup> $R_L = 8\Omega$ , $A_V = 2$ , $V_{ripple} = 200 mVpp$ , input grounded $f = 217 Hz$ $f = 1 kHz$		55 55	63 66		dB
t <sub>WU</sub>	Wake-up time ( $C_b = 1 \mu F$ )			80		ms
t <sub>SD</sub>	Shutdown time (C <sub>b</sub> = 1µF)			10		μs
V <sub>SDH</sub>	Shutdown Voltage level high					V
V <sub>SDL</sub>	Shutdown Vo	ltage level low			0.4	V



### **Electrical Characteristics**

( $V_{DD} = 2.6V$ ,  $T_A = 25$ °C unless otherwise specified)

Symbol	Parameter			Тур.	Max.	Unit
I <sub>CC</sub>		Supply current No input signal, no load			4	mA
I <sub>SD</sub>	Shutdown cur No input signa	rent al, $V_{SD}$ = $G_{ND}$ , $R_L$ = $8\Omega$		0.1	2	uA
V <sub>oo</sub>	Output offset v No input signa	<u> </u>		2	30	mV
P <sub>out</sub>	Output power	THD+N = 1% (max); f = 1kHz (8Ω)	0.20	0.27		mW
THD + N	Total harmonic distortion + noise $P_{out} = 0.15  \text{Wrms},  A_V = 2,  20 \text{Hz} \leq F \leq 20 \text{kHz}, \\ R_L = 8  \Omega$			0.09	0.30	%
PSRR	Power supply rejection ratio <sup>(1)</sup> $R_L = 8\Omega, A_V = 2, V_{ripple} = 200 mVpp, input grounded \\ f = 217 Hz \\ f = 1 kHz$			60 62		dB
t <sub>WU</sub>	Wake-up time ( $C_b = 1\mu F$ )			70		ms
t <sub>SD</sub>	Shutdown time ( $C_b = 1\mu F$ )			10		μs
V <sub>SDH</sub>	Shutdown Voltage level high					V
V <sub>SDL</sub>	Shutdown Vo	tage level low			0.4	V



## **Typical Operating Characteristics**

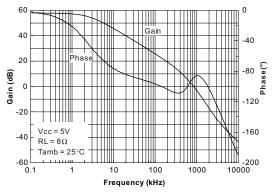


Figure 4. Open loop frequency response

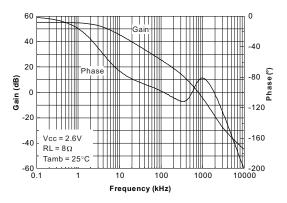


Figure 6. Open loop frequency response

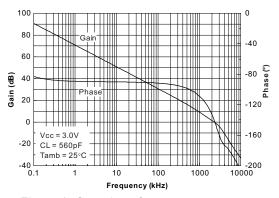


Figure 8. Open loop frequency response

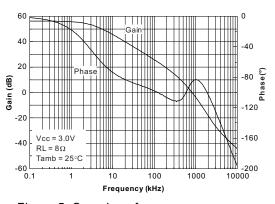


Figure 5. Open loop frequency response

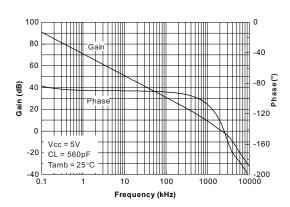


Figure 7. Open loop frequency response

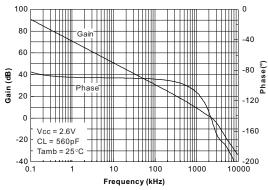


Figure 9. Open loop frequency response



### Typical Operating Characteristics (Continued)

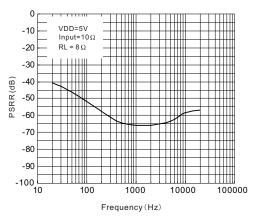


Figure 10. PSRR vs.power supply

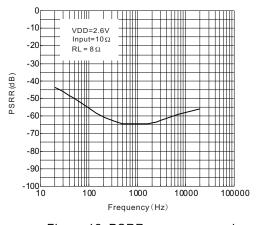


Figure 12. PSRR vs.power supply

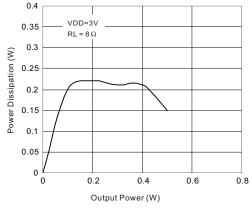


Figure 14. Power Dissipation vs Output Power

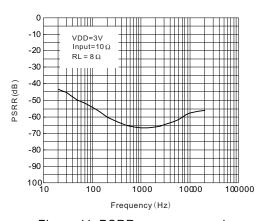


Figure 11. PSRR vs.power supply

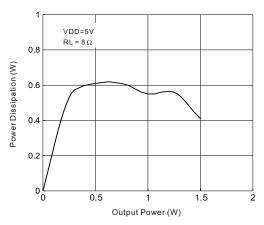


Figure 13. Power Dissipation vs Output Power

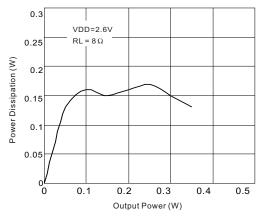


Figure 15. Power Dissipation vs Output Power



### Typical Operating Characteristics (Continued)

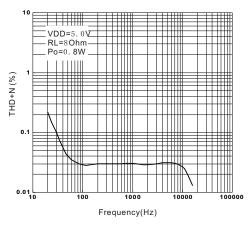


Figure 16.THD+N vs Frequency

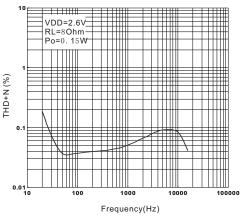


Figure 18.THD+N vs Frequency

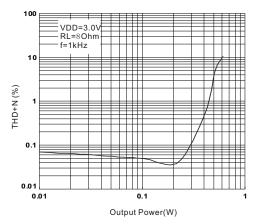


Figure 20.THD+N vs Output Power

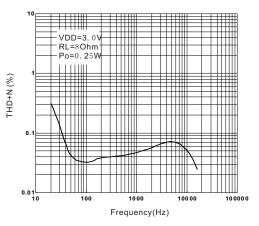


Figure 17.THD+N vs Frequency

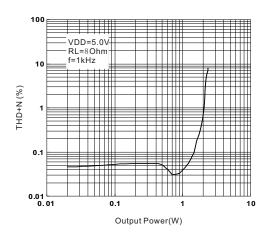


Figure 19.THD+N vs Output Power

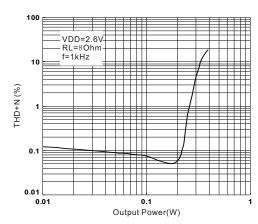


Figure 21.THD+N vs Output Power



## Typical Operating Characteristics (Continued)

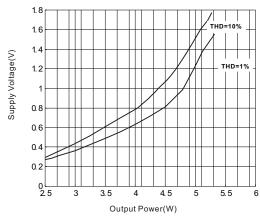


Figure 22. Output Power vs Supply Voltage

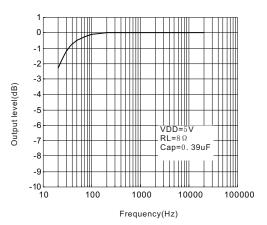


Figure 23.Frequency Response vs Input Capacitor Size

### **Applications Information**

### **Bridged Configuration principle**

The MC4996 is a monolithic power amplifier with a BTL output type. BTL (bridge tied load) means that each end of the load is connected to two single-ended output amplifiers. Thus, we have:

Single-ended output 1 = Vout1 = Vout (V) Single ended output 2 = Vout2 = -Vout (V) and Vout1 - Vout2 = 2Vout (V)

The output power is:

$$P_{out} = \frac{(2V_{out_{RMS}})^2}{R_L}$$

For the same power supply voltage, the output power in BTL configuration is four times higher than the output power in single ended configuration.

#### Gain in a typical application schematic

The typical application schematic is shown in *Figure 2*. In the flat region (no Cin effect), the output voltage of the first stage is (in Volts):

$$V_{out1} = (-V_{in}) \frac{R_{feed}}{R_{in}}$$

For the second stage: Vout2 = -Vout1 (V) The differential output voltage is (in Volts):

$$V_{out2} - V_{out1} = 2V_{in} \frac{R_{feed}}{R_{in}}$$

The differential gain named gain (Gv) for more convenient usage is:

$$G_v = \frac{V_{out2} - V_{out1}}{V_{in}} = 2 \frac{R_{feed}}{R_{in}}$$

Vout2 is in phase with Vin and Vout1 is phased 180° with Vin. This means that the positive terminal of the loudspeaker should be connected to Vout2 and the negative to Vout1.

#### **Power Dissipation and Efficiency**

Hypotheses:

- Load voltage(Vout) and current (lout) are sinusoidal.
- Supply voltage is a pure DC source (Vcc). Regarding the load we have:

$$V_{out} = V_{PEAK} \sin \omega t (V)$$
;

$$I_{out} = \frac{V_{out}}{R_1}$$
 (A)

$$P_{out} = \frac{V_{PEAK}^{2}}{2R_{L}} \qquad (W)$$

Therefore, the average current delivered by the supply voltage is:

$$I_{CC_{AVG}} = 2 \frac{V_{PEAK}}{\pi R_L}$$
 (A)

The power delivered by the supply voltage is:

$$P_{\text{supply}} = V_{\text{CC}} \cdot I_{\text{CC}_{\text{AVG}}} \qquad (W)$$

Then, the power dissipated by each amplifier is:

$$P_{diss} = P_{supply} - P_{out}$$
 (W)

$$P_{diss} = \frac{2\sqrt{2}V_{CC}}{\pi\sqrt{R_1}}\sqrt{P_{out}} - P_{out}$$

and the maximum value is obtained when:

$$\frac{\delta P_{diss}}{\delta P_{out}} = 0$$

and its value is:

$$P_{diss_{max}} = \frac{2V_{CC}^2}{\pi^2 R_L}$$
 (W)

Note: This maximum value is only dependent on power supply voltage and load values. The efficiency is the ratio between the output power and the power supply:

$$\eta = \frac{P_{out}}{P_{supply}} = \frac{\pi V_{PEAK}}{4V_{CC}}$$

The maximum theoretical value is reached when VPEAK = VCC, so:

$$\frac{\pi}{4}$$
 = 78.5%

#### Shutdown time

When the shutdown command is set, the time required to put the two output stages in high impedance and the internal circuitry in shutdown mode is a few microseconds.

In shutdown mode, Bypass pin and Vin- pin are short circuited to ground by internal switches. This allows a quick discharge of Cb and Cin capacitors.

#### **POP** performance

Pop performance is intimately linked with the size of the input capacitor Cin and the bias voltage bypass capacitor Cb.

The size of Cin is dependent on the lower cut-off frequency and PSRR values requested. The size of Cb is dependent on THD+N and PSRR values requested at lower frequencies.

Moreover, Cb determines the speed with which the amplifier turns ON. In order to reach near zero pop and click, the equivalent input constant time

$$\tau_{in}$$
 = (R<sub>in</sub> + 2K $\Omega$ )xC<sub>in</sub> (s) with R<sub>in</sub>  $\geq$  5k $\Omega$ 

By following the previous rules, the MC4996 can reach near zero pop and click even with high gains such as 20 dB.

#### Wake-up time(twu)

When the shutdown is released to put the device ON, the bypass capacitor Cb will not be charged immediately. As Cb is directly linked to the bias of the amplifier, the bias will not work properly until the Cb voltage is correct. The time to reach this voltage is called wake-up time or two and specified in the electrical characteristics table with Cb =  $1\mu F$ .

#### Decoupling of the circuit

Two capacitors are needed to correctly bypass the MC4996: a power supply bypass capacitor Cs and a bias voltage bypass capacitor Cb.

 $C_s$  has particular influence on the THD+N in the high frequency region (above 7kHz) and an indirect influence on power supply disturbances. With a value for  $C_s$  of  $1\mu F$ , you can expect THD+N levels similar to those shown in the datasheet.

In the high frequency region, if  $C_s$  is lower than  $1\mu F$ , it increases THD+N and disturbances on the power supply rail are less filtered.

On the other hand, if Cs is higher than  $1\mu F$ , those disturbances on the power supply rail are more filtered.

C<sub>b</sub> has an influence on THD+N at lower frequencies, but its function is critical to the final result of PSR (with input grounded and in the lower frequency region).

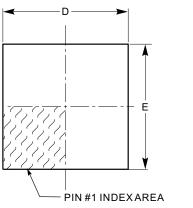
If  $C_b$  is lower than  $1\mu F$ , THD+N increases at lower frequencies and PSRR worsens. If  $C_b$  is higher than  $1\mu F$ , the benefit on THD+N at lower frequencies is small, but the benefit to PSRR is substantial.

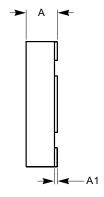
Note that C<sub>in</sub> has a non-negligible effect on PSRR at lower frequencies. The lower the value of Cin, the higher the PSRR.



## **Package Information**

### **DFN 2X2\_8L**

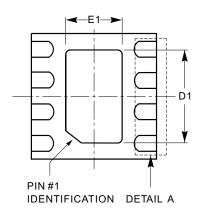


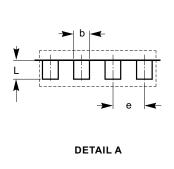


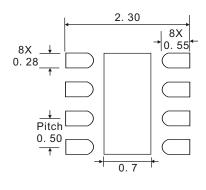
SYMBOL	MIN	NOM	MAX
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D	2.00BSC		
D1	1.10	1.20	1.30
E	2.00BSC		
E1	0.50	0.60	0.70
е	0.50 BSC		
L	0.30	0.35	0.40

**TOP VIEW** 

SIDE VIEW







UNIT:mm

#### **BOTTOM VIEW**

Recommended Land Pattern

#### Notes:

- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MO-229.